

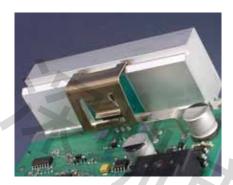
深圳市优博尔科技有限公司 www.youboer.com

业务及技术专线: 0755-27918301 13312987566 Hepburn@youboer.com 吕先生 **Hi-Flow**® **300P** 

Electrically Insulating, Thermally Conductive Phase Change Material

#### **Features and Benefits**

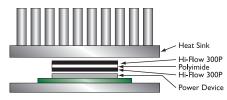
- Thermal impedance: 0.13°C-in<sup>2</sup>/W (@25 psi)
- Field-proven polyimide film
- excellent dielectric performance
- excellent cut-through resistance
- Outstanding thermal performance in an insulated pad



Hi-Flow 300P consists of a thermally conductive 55°C phase change compound coated on a thermally conductive polyimide film. The polyimide reinforcement makes the material easy to handle and the 55°C phase change temperature minimizes shipping and handling problems.

Hi-Flow 300P achieves superior values in voltage breakdown and thermal performance when compared to its competition. The product is supplied on an easy release liner for exceptional handling in high volume manual assemblies. Hi-Flow 300P is designed for use as a thermal interface material between electronic power devices requiring electrical isolation to the heat sink.

Bergquist suggests the use of spring clips to assure constant pressure with the interface and power source. Please refer to thermal performance data to determine nominal spring pressure for your application.



We produce thousands of specials. Tooling charges vary depending on tolerances and complexity of the part.

TYPICAL PROPERTIES OF HI-FLOW 300P						
PROPERTY	IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Color	Green		Green		Visual	
Reinforcement Carrier	Polyimide		Polyimide			
Thickness (inch) / (mm)	0.004 - 0.005		0.102 - 0.127		ASTM D374	
Film Thickness (inch) / (mm)	0.001 - 0.002		0.025 - 0.050		ASTM D374	
Elongation (%45° to Warp and Fill)	40		40		ASTM D882A	
Tensile Strength (psi) / (MPa)	7000		48		ASTM D882A	
Continuous Use Temp (°F) / (°C)	302		150		_	
Phase Change Temp (°F) / (°C)	131		55		ASTM D3418	
ELECTRICAL						
Dielectric Breakdown Voltage (Vac)	5000		5000		ASTM D149	
Dielectric Constant (1000 Hz)	4.5		4.5		ASTM D150	
Volume Resistivity (Ohm-meter)	10 <sup>12</sup>		10 <sup>12</sup>		ASTM D257	
Flame Rating	V-O		V-O		U.L. 94	
THERMAL						
Thermal Conductivity (W/m-K) (1)	1.6		1.6		ASTM D5470	
THERMAL PERFORMANCE vs PRESSURE						
Pressure (psi)		10	25	50	100	200
TO-220 Thermal Performance (°C/W) 0.0010"		0.95	0.94	0.92	0.91	0.90
TO-220 Thermal Performance (°C/W) 0.0015"		1.19	1.17	1.16	1.14	1.12
TO-220 Thermal Performance (°C/W) 0.0020"		1.38	1.37	1.35	1.33	1.32
Thermal Impedance (°C-in²/W) 0.0010" (2)		0.13	0.13	0.12	0.12	0.12
Thermal Impedance (°C-in²/W) 0.0015" (2)		0.17	0.16	0.16	0.16	0.15
Thermal Impedance (°C-in²/W) 0.0020" (2)		0.19	0.19	0.19	0.18	0.18
1) This is the measured thermal conductivity of the Hi-Flow coating. It represents one conducting layer in a three-layer laminate. The						

 This is the measured thermal conductivity of the Hi-Flow coating. It represents one conducting layer in a three-layer laminate. The Hi-Flow coatings are phase change compounds. These layers will respond to heat and pressure induced stresses. The overall conductivity of the material in post-phase change, thin film products is highly dependent upon the heat and pressure applied. This characteristic is not accounted for in ASTM D5470, Please contact Bergquist Product Management if additional specifications are required.

2) The ASTM D5470 test fixture was used and the test sample was conditioned at 70°C prior to test. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the

## Typical Applications Include:

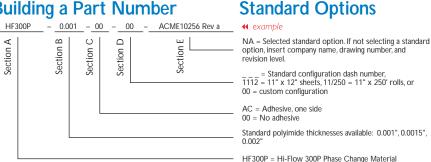
- Spring / clip mounted
- Discrete power semiconductors and modules

### **Configurations Available:**

surface roughness, flatness and pressure applied.

• Roll form, die-cut parts and sheet form, with or without pressure sensitive adhesive

### Building a Part Number



Note: To build a part number, visit our website at www.bergquistcompany.com.

Hi- Flow®: U.S. Patent 6,197,859 and others

# BEROUIST

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The Bergquist Company -North American Headquarters The Bergquist Company European Headquarters 18930 West 78th Street Chanhassen, MN 55317 Phone: 800-347-4572 Bramenberg 9a, 3755 BT Eemnes Netherlands Phone: 31-35-5380684 Fax: 31-35-5380295 Fax: 952-835-0430

The Bergquist Company - Asia Nom 15, BY Wah Wai Industrial Centre No. 38-40, Au Pui Wan Street Fotan, Shatin, N. T. Hong Kong Ph. 852.2690.9296 Fax: 852.2690.2344 All statements, technical information and recommendations herein are based on tests we believe to be reliable, and THE FOLLOWING IS MADE IN LIEU OF ALL WARRANTIES, EXPRESSED OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MARKETABILITY AND FITNESS FOR PURPOSE. Sellers' and manufacturers' only obligation shall be to replace such quantity of the product proved to be defective. Before using user shall determine the suitability of the product for its intended use, and the user assumes all risks and liability whatsoever in connection therewith. NETHER SELLER NOR MANUFACTURER SHALL BE LIABLE EITHER INTORT OR IN CONTRACT FOR ANY LOSS OR DAMAGE, DIRECT, INCIDENTAL, OR CONSEQUENTIAL, INCLUDING LOSS OF PROFITS OR REVENUE ARSING OUT OF THE USE OR THE INABILITY TO USE A PRODUCT. No statement, purchase order or recommendations by seller or purchaser not contained herein shall have any force or effect unless in an agreement signed by the officers of the seller and manufacturer.

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